

SPEC NO.: 181119

Specification

TO:STE

Model Name: Ceramic Resonator PART NO: ZTACC3.36MG CUSTOMER PART NO.:

Approval sheet:	
	Yes
Approved	No.
Customer's comments are welcomed here.	
Please return this copy as a certificate of your approval by Email.	

STRONG ELECTRONICS&TECHNOLOGY LIMITED

Date:

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Approved By



History Record

Date	Part No.	SPEC No.	Description.	Remarks.
			X	
CX			9	
RoHS Compliant Lead free Lead-free soldering	conflict REACH mineral free compliant	Min		
ISO9001:2000	ISO14001:2004	Approved by	Check by	Design by
Reversions	Total Page	Nov-17-2017 Xu gang dong	NOV-17-2017 Liu jun	NOV-17-2017 Wang hon



1. SCOPE

This specification shall cover the characteristics of the ceramic resonator with the type ZTACC3.36MG

2. PART NO.

PART NUMBER	ZTACC3. 36MG
CUSTOMER PART NO	

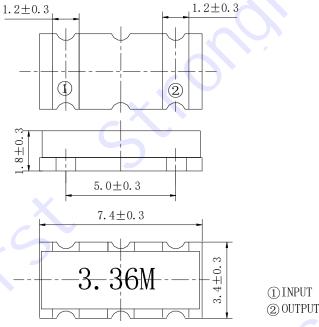
3. OUTLINE DIMENSIONS AND MARK

3.1 Appearance: No visible damage and dirt.

3.2 Construction: SMD ceramic packaging.

3.3 The products conform to the RoHS directive and national environment protection law.

3.4 Dimensions and mark



①INPUT



4. ELECTRICAL SPECIFICATIONS

4.1 RATING

Items	Requirement
Withstanding Voltage (V)	50 (DC, 1min)
Insulation Resistance Ri, $(M \Omega)$ min.	500 (10V, 1min)
Operating temperature	-25℃~85℃
Storage temperature	-55℃~85℃
Rating Voltage U _R (V)	6V DC
Rating voltage OR (V)	15V p-p

4.2 ELECTRICAL SPECIFICATIONS

Items	Requirement
Oscillation Frequency Fosc (MHz)	3.360
Frequency Accuracy (%)	±0.5
Resonant Impedance Ro (Ω) max.	30
Temperature Coefficient of Oscillation	± 0.3 (Oscillation Frequency
Frequency (%) max.	drift, -25°C∼+85°C)
Oscillation Frequency	± 0.3 (From initial value)
Aging Rate (10years) (%) max *	

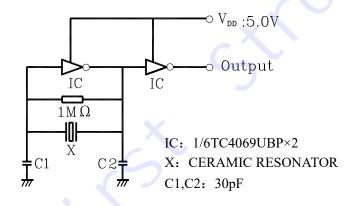
^{*} Components shall be left in a chamber of $+85\pm2^{\circ}$ C for 1000 hours, then measured after leaving in natural condition for 1 hour.

5. TEST

5.1 Test Conditions

Parts shall be tested under the condition (Temp.: $20\pm15\,^{\circ}$ C, Humidity: $65\pm20\%$ R.H.) unless the standard condition(Temp.: $25\pm2\,^{\circ}$ C, Humidity: $65\pm5\%$ R.H.) is regulated to measure.

5.2 Test Circuit





6 PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

No	Item	Condition of Test	Performance Requirements
6.1	Humidity	Keep the resonator at 40 °C±2 °C and 90%-95% RH for 96h. Then Release the resonator into the room Condition for 1h prior to the Measurement.	It shall fulfill the specifications in Table 1.
6.2	High Temperature Exposure	Subject the resonator to $85 \degree C \pm 2 \degree C$ for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
6.3	Low Temperature Exposure	Subject the resonator to -55 °C ± 2 °C for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
6.4	Temperature Cycling	After temperature cycling of blow table was performed 5 times, resonator shall be measured after being placed in natural conditions for 1h. Temperature $-25\pm3^{\circ}$ $30\pm3^{\circ}$ $30\pm3^{\circ}$ $30\pm3^{\circ}$	It shall fulfill the specifications in Table 1.
6.5	Vibration	Subject the resonator to vibration for 2h each in x, y and z axis With the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10 Hz—55Hz.	It shall fulfill the specifications in Table 1.
6.6	Mechanical Shock	Drop the resonator randomly onto a wooden floor from the height of 100cm 3 times.	It shall fulfill the specifications in Table 1.
6.7	Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1h before measurement. 10s max	It shall fulfill the specifications in Table 1.

(To be continued)



6 PHYSICAL AND ENVIRONMENAL CHARACTERISICS

0 111	0 THI SICAL AND ENVIRONMENAL CHARACTERISICS			
No	Item	Condition of Test	Performance Requirements	
6.8	Solder Ability	Dipped in 245 °C ±5 °C solder bath for $3s\pm0.5$ s with rosin flux (25wt% ethanol solution.)	The terminals shall be at least 95% covered by solder.	
6.9	Board Bending	Mount a glass-epoxy board (Width=40mm,thickness=1.6mm),then bend it to 1mm displacement and keep it for 5s. (See the following figure) PRESS D.U.T. J.	Mechanical damage such as breaks shall not occur.	

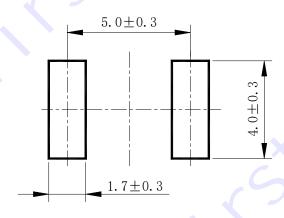
Table 1

Item	Specification after test	
Oscillation Frequency Change Δ fosc/fosc (%) max.	±0.3	
Resonant Impedance Ro (Ω) max.	35	
The limits in the above table are referenced to the initial measurements.		

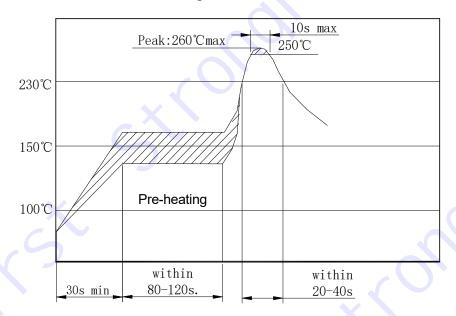


7 RECOMMENDED LAND PATTERN AND REFLOW SOLDERING STANDARD CONDITIONS

7.1Recommended land pattern



7.2Recommended reflow soldering standard conditions

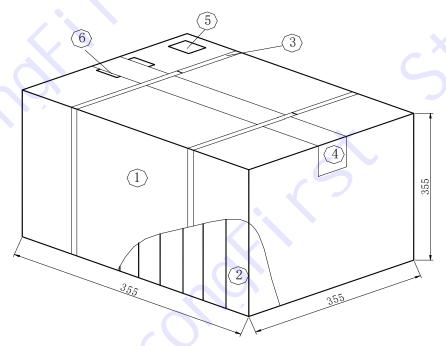




To protect the products in storage and transportation, it is necessary to pack them (outer and inner package).

8.1 On paper pack, the following requirements are requested.

8.1.1 Dimensions and Mark



NO.	Name	Quantity
1	Package	1
2	Inner Box	10
3	Belt	2.9 m
4	Adhesive tape	1.2 m
5	Label	1
6	Certificate of approval	1

8.1.2 Section of package



Package is made of corrugated paper with thickness of 0.8cm.Package has 10 inner boxes, each box has 1 reel(each reel for plastic bag)

8.1.3 Quantity of package

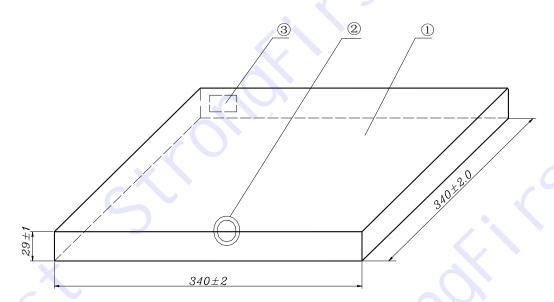
Per plastic reel 4000 pieces of piezoelectric ceramic part

Per inner box 1 reel

Per package 10 inner boxes

(40000 pieces of piezoelectric ceramic part)

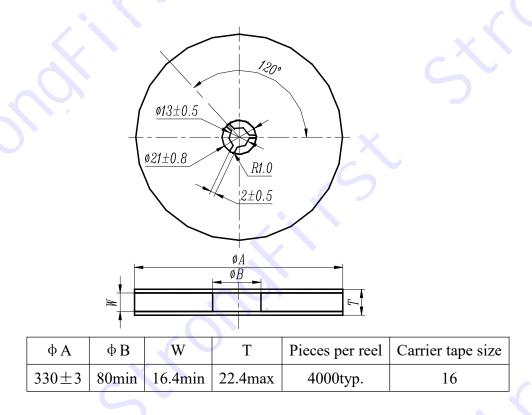
8.1.4 Inner Box Dimensions



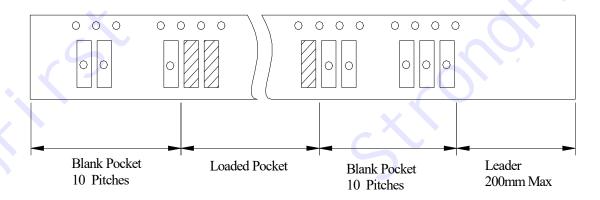
NO.	Name	Quantity
1	Inner Box	1
2	QC Label	1
3	Label	1



- 8.2 On reel pack, the following requirements are requested.
- 8.2.1 Reel Dimensions

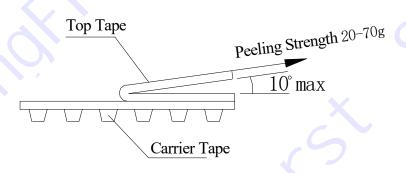


8.2.3 Packing Method Sketch Map





8.2.4Test Condition Of Peeling Strength



9. OTHER

- 9.1 Caution
- 9.1.1 Don't apply excess mechanical stress to the component and terminals at soldering. Do not use this product with bend.
- 9.1.2 Do not clean or wash the component for it is not hermetically sealed.
- 9.1.3 Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.
- 9.1.4 Don't be close to fire.
- 9.1.5 This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit
- 9.1.6 Expire date (Shelf life) of the products is 12 months after delivery under the conditions of a sealed and an unopened package. Please use the products within 12 months after delivery. If you store the products for a long time (more than 12 months), use carefully because the products may be degraded in the solderability or rusty. Please confirm solderability and characteristics for the products regularly.
- 9.1.7 Please contact us before using the product as automobile electronic component.
- 9.2 Notice
- 9.2.1 Please return one of this specification after your signature of acceptance.



9.2.2 When something gets doubtful with this specifications, we shall jointly work to get an agreement.

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